

Docket No.

Armstrong, Westerman & Hattori, LLP

## DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

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COMPOSITION, AND ITS PRODUCTION PROCESS

the specification of which is attached hereto unless the following is checked

☒ was filed on January 15, 2003 as United States Application Number \_\_\_\_\_ or PCT International Application Number PCT/JPO3/00252 and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

(List prior foreign applications. See note A below)

2002-005413  
 (Number)

Japan  
 (Country)

15/01/02  
 (Day/Month/Year Filed)

Priority Claimed

☒ Yes ☐ No

2002-005414  
 (Number)

Japan  
 (Country)

15/01/02  
 (Day/Month/Year Filed)

☒ Yes ☐ No

\_\_\_\_\_  
 (Number)

\_\_\_\_\_  
 (Country)

\_\_\_\_\_  
 (Day/Month/Year Filed)

☐ Yes ☐ No

\_\_\_\_\_  
 (Number)

\_\_\_\_\_  
 (Country)

\_\_\_\_\_  
 (Day/Month/Year Filed)

☐ Yes ☐ No

(See note B below)

☐ See attached list for additional prior foreign applications.

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List prior U.S. Applications)

Status

\_\_\_\_\_  
 (Application Serial No.)

\_\_\_\_\_  
 (Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

\_\_\_\_\_  
 (Application Serial No.)

\_\_\_\_\_  
 (Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

\_\_\_\_\_  
 (Application Serial No.)

\_\_\_\_\_  
 (Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



23850

PATENT TRADEMARK OFFICE

Please direct all communications to the following address:



23850

PATENT TRADEMARK OFFICE

1-0 Full name of sole or first inventor (given name, family name) Xingzhou JIN

(See note C above) Inventor's Signature Xingzhou Jin Date July 10, 2004

Residence Same as post office address Citizenship China

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2-0 Full name of second inventor (given name, family name) Hiroyuki ISHII

Inventor's Signature Hiroyuki ISHII Date July 10, 2004

Residence Same as post office address Citizenship Japan

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3-0 Full name of third inventor (given name, family name) Masataka MIYAMURA

Inventor's Signature Masataka Miyamura Date July 10, 2004

Residence Same as post office address Citizenship Japan

Post Office Address 4-25-4, Shichirigahama-higashi, Kamakura-Shi, KANAGAWA 248-0025 JAPAN SPX

4-0 Full name of fourth inventor (given name, family name) Hiroshi ITATANI

Inventor's Signature Hiroshi Itatani Date July 10, 2004

Residence Same as post office address Citizenship Japan

Post Office Address 1-2-1-1014, Namiki, Kanazawa-Ku, Yokohama-Shi, KANAGAWA 236-0005 JAPAN SPX

5-0 Full name of fifth inventor (given name, family name) Shinichiro HORI

Inventor's Signature Shinichiro Hori Date July 10, 2004

Residence Same as post office address Citizenship Japan

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6-0 Full name of sixth inventor (given name, family name) Akihito TANIGUCHI

Inventor's Signature (not reached) Date \_\_\_\_\_

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Full name of seventh inventor (given name, family name) \_\_\_\_\_

Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_

Residence \_\_\_\_\_ Citizenship \_\_\_\_\_

Post Office Address \_\_\_\_\_

Full name of eighth inventor (given name, family name) \_\_\_\_\_

Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_

Residence \_\_\_\_\_ Citizenship \_\_\_\_\_

Post Office Address \_\_\_\_\_